

TERMINATION SURFACE MOUNT 8 WATT



DATA SHEET PART NUMBER: SMT1206AF

SHEET 1 OF 1

EN 13-2345 07/11/2013

FEATURES

Low Profile Surface Mount

High Power Low VSWR

Ideal For Automated Assembly

APPLICATIONS

Mobile Networks

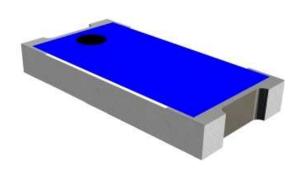
Broadcast

High Power Amplifiers

Instrumentation

Isolators Military

Satellite Communications



GENERAL DESCRIPTION

EMC Technology's surface mount terminations are designed for direct installation on printed circuit boards and manufactured using thick film technology. Edge metallization on two sides forms the solder fillets for stronger attachment, easier inspection, and increased heat removal area. The devices are available in Alumina, Aluminum Nitride or Beryllium Oxide.

SPECIFICATIONS

1.0 ELECTRICAL

Nominal Impedance: 50Ω

Frequency Range: DC – 6.0 GHz

VSWR: 1.25:1 Max @ DC - 3.0 GHz

1.60:1 Max @ 3.0 - 6.0 GHz

Temperature ± 200 PPM/℃ Max Power Rating: 8 Watts (Derating Chart)

Operating Temperature: -55 $^{\circ}$ To +125 $^{\circ}$

DC Resistance: $50 \Omega \pm 5\%$

2.0 MECHANICAL

Substrate Alumina Resistive Film: Thick Film

Metallization: Thick Film, Silver Plated

3.0 UNIT MARKING

Input Dot

4.0 PACKAGING

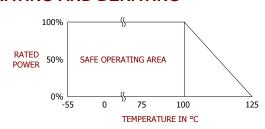
Standard: Tape and Reel

Optional: Available Upon Request

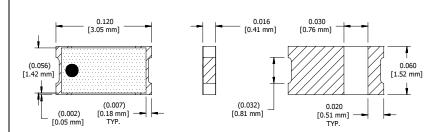
5.0 PART

Part Identifier: SMT1206AF

POWER RATING AND DERATING



MECHANICAL OUTLINE



Unless otherwise specified: TOLERANCE: ± .010

* Note: Specifications are subject to change without notice.

**NOTE: Power handling may vary depending on mounting and heat sinking method.



